

iMAPS New England – 44th Symposium & Expo

The Largest Regional Symposium Dedicated to

Microelectronics Assembly and Packaging

Boxboro Regency Hotel & Conference Center

Boxborough, Massachusetts

May 2, 2017

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- Advanced Semiconductor Packaging
- Printed Electronics - Additive Manufacturing
- Nanoelectronic - Optoelectronic Packaging

Symposium Technical Chair

Dr. Parshant Kumar, Draper

Please e-mail your 250 word abstract to:

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